Ahmed Cheriet

List of Publications by Year in descending order

Source: https://exaly.com/author-pdf/5976781/publications.pdf

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| 10 | 56 | 5 | 7 |
|----------|----------------|--------------|-------------------|
| papers | citations | h-index | g-index |
| 10 | 10 | 10 | 61 citing authors |
| all docs | docs citations | times ranked | |

| # | Article | IF | CITATIONS |
|----|---|-----|-----------|
| 1 | Design and experimental investigation of a bi-directional valveless electromagnetic micro-pump. Sensors and Actuators A: Physical, 2018, 272, 310-317. | 4.1 | 17 |
| 2 | 3D Finite Volume Modeling of ENDE Using Electromagnetic <i>T</i> Formulation. Journal of Sensors, 2012, 2012, 1-6. | 1.1 | 11 |
| 3 | Fuzzy logic control of electrodynamic levitation devices coupled to dynamic finite volume method analysis. Applied Mathematical Modelling, 2013, 37, 5951-5961. | 4.2 | 8 |
| 4 | Bi-eddy current sensor based automated scanning system for thickness measurement of thick metallic plates. International Journal of Advanced Manufacturing Technology, 2018, 96, 2867-2873. | 3.0 | 7 |
| 5 | 3D movement simulation technique in FVM method application to eddy current non destructive testing. COMPEL - the International Journal for Computation and Mathematics in Electrical and Electronic Engineering, 2009, 28, 77-84. | 0.9 | 5 |
| 6 | Skin effect based technique in eddy current nonâ€destructive testing for thickness measurement of conductive material. IET Science, Measurement and Technology, 2019, 13, 255-259. | 1.6 | 5 |
| 7 | Accurate measurement of Aluminum layer thickness in a multilayer material using eddy current sensor. , $2016, \ldots$ | | 2 |
| 8 | Transient axisymmetric FVM analysis of electodynamic levitation devices. EPJ Applied Physics, 2013, 61, 10602. | 0.7 | 1 |
| 9 | Gap Estimation of Disbanding Failure Appears in Hybrid Laminate Material by Means of an Eddy Current Evaluation. , 2018, , . | | O |
| 10 | Arbitrary movement simulation using 3D NC-FVM for electromagnetic problems. COMPEL - the International Journal for Computation and Mathematics in Electrical and Electronic Engineering, 2018, 37, 1306-1314. | 0.9 | 0 |